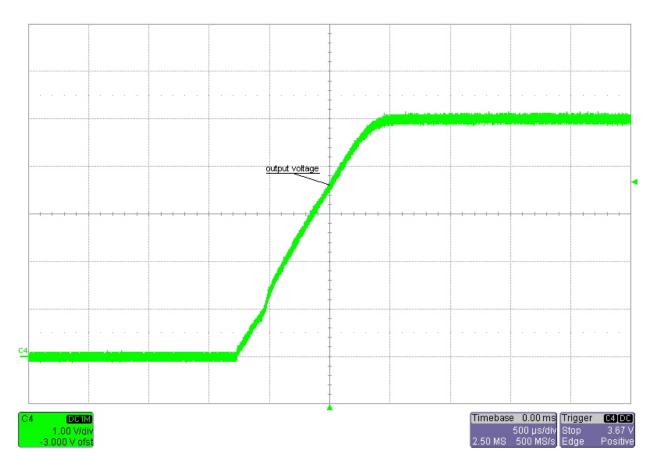


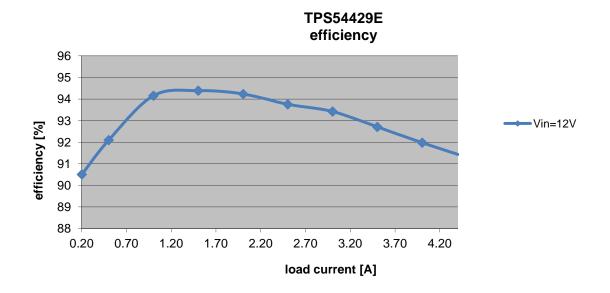
1 TPS54229EEVM (5.0V@4.4A)

1.1 Startup

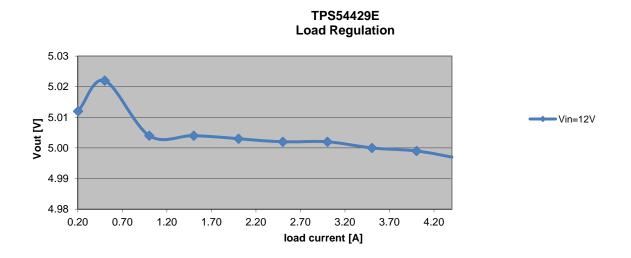




1.2 Efficiency

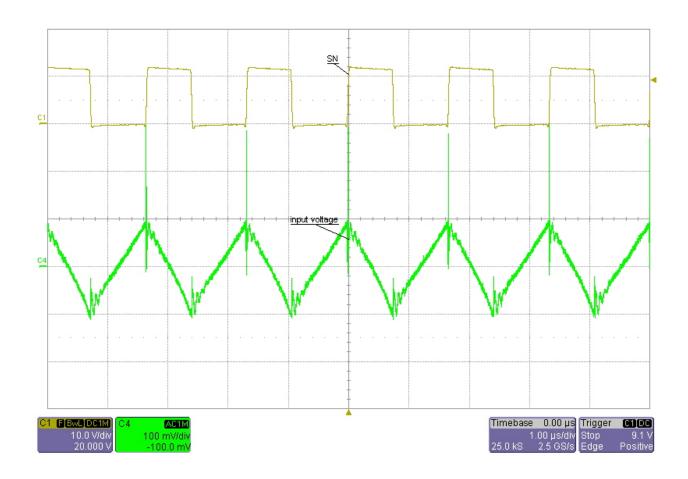


1.3 Load regulation



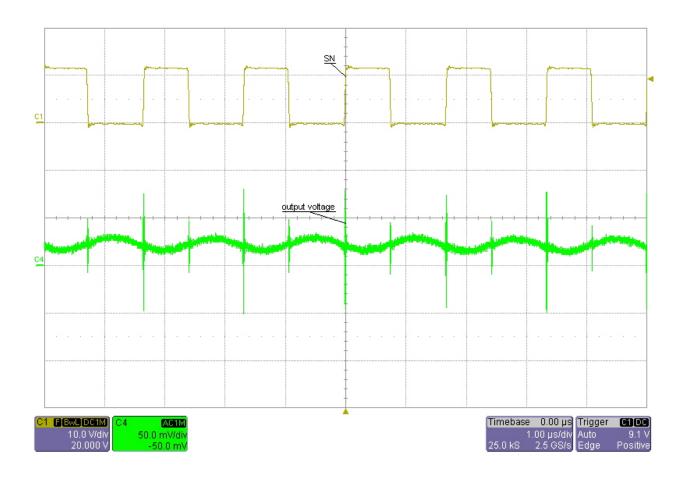


1.4 Input ripple voltage



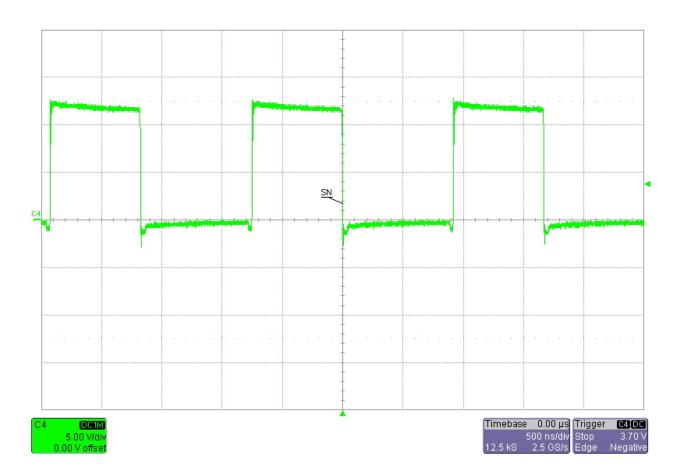


1.5 Output ripple voltage





1.6 Switch Node

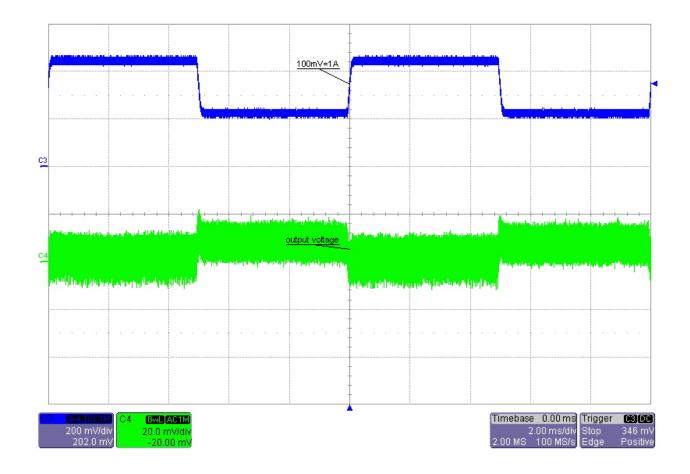




1.7 Load Transients

Input voltage = 12V

Load current = 2.2A to 4.4A



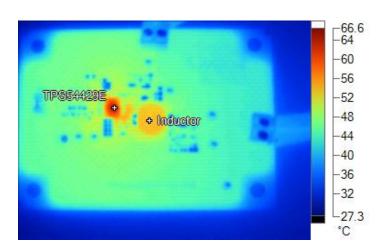


1.8 Thermal Analysis

The images below show the infrared images taken from the FlexCam after 15min at full load (5V@4.4A).

Input voltage
$$= 12V$$

Ambient temperature $= 25^{\circ}C$

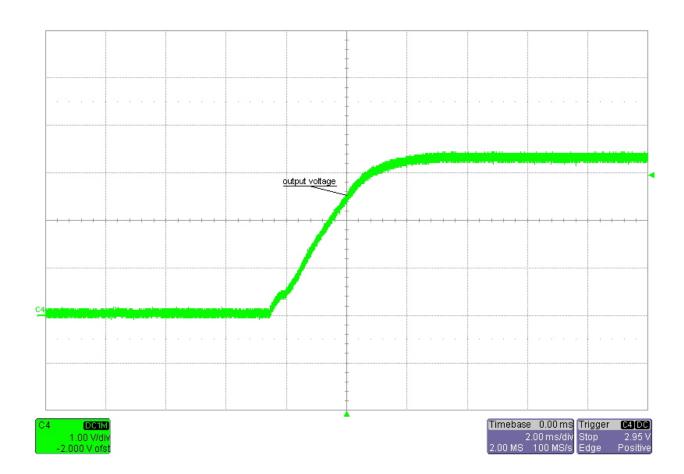


Name	Temperature	
Inductor	53.6°C	
TPS54429E	65.6°C	



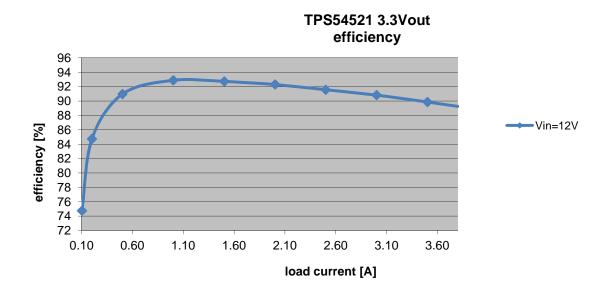
2 TPS54521EVM (3.3V@3.8A)

2.1 Startup

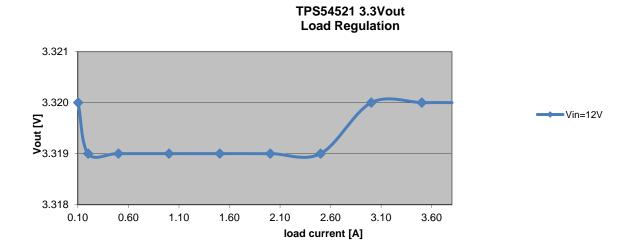




2.2 Efficiency

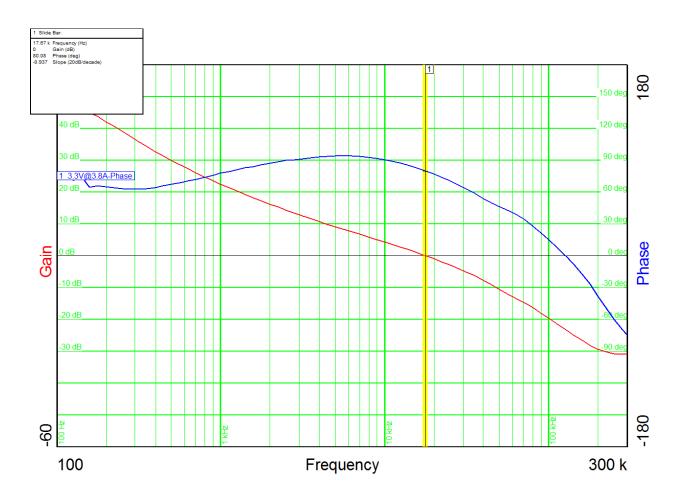


2.3 Load regulation





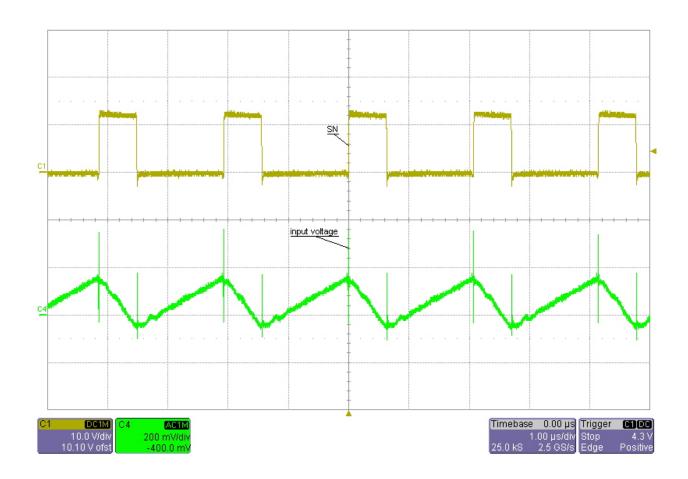
2.4 Control Loop Frequency Response



Input voltage = 12VPhase margin $= 80.1^{\circ}$ Bandwidth = 17.7 kHz

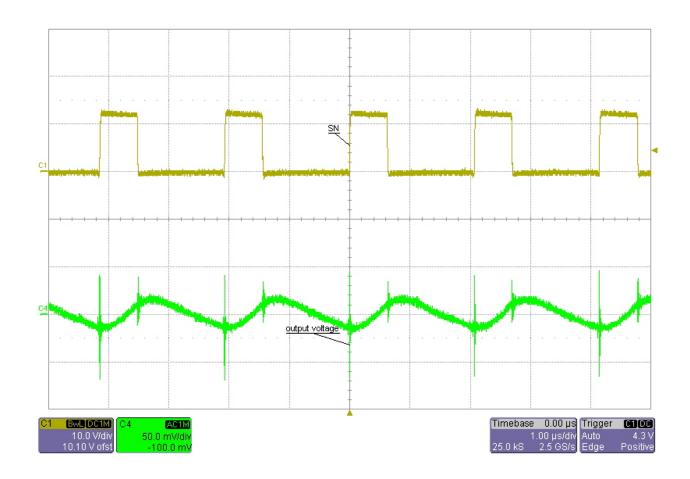


2.5 Input ripple voltage



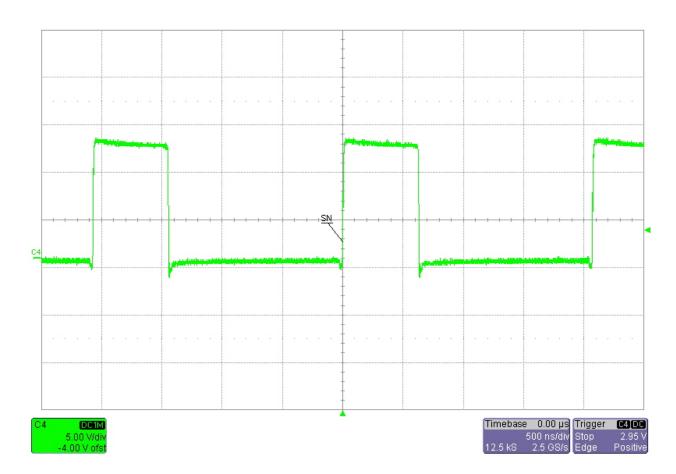


2.6 Output ripple voltage





2.7 Switch Node

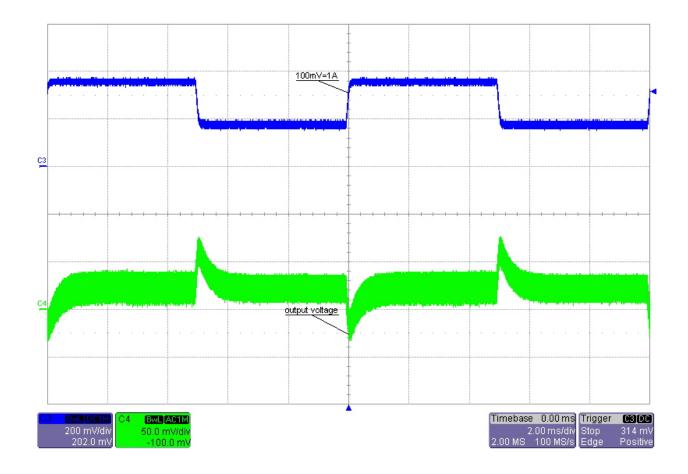




2.8 Load Transients

Input voltage = 12V

Load current = 1.9A to 3.8A



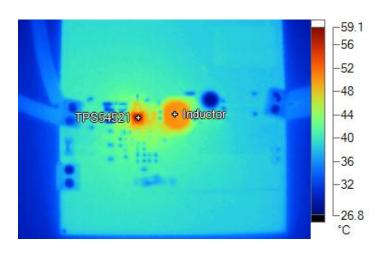


2.9 Thermal Analysis

The images below show the infrared images taken from the FlexCam after 15min at full load (3.3V@3.8A).

Input voltage
$$= 12V$$

Ambient temperature $= 25^{\circ}C$

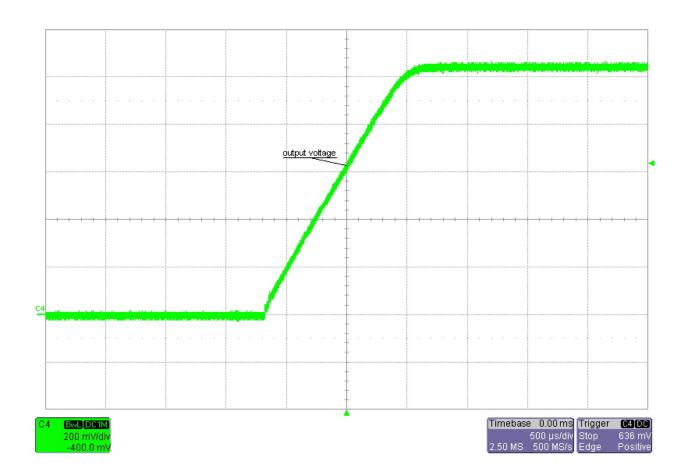


Name	Temperature	
Inductor	50.1°C	
TPS54521	58.0°C	



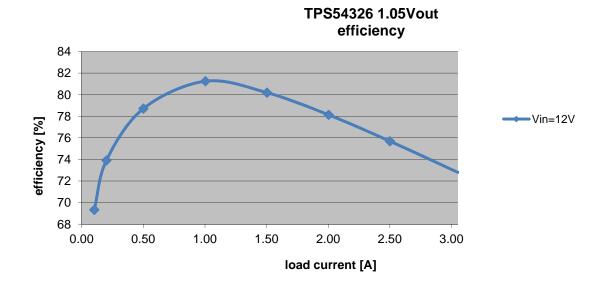
3 TPS54326EVM (1.05V@3.05A)

3.1 Startup

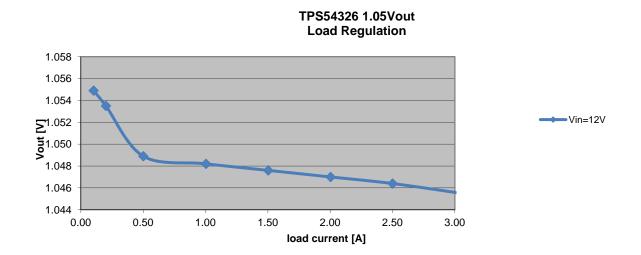




3.2 Efficiency

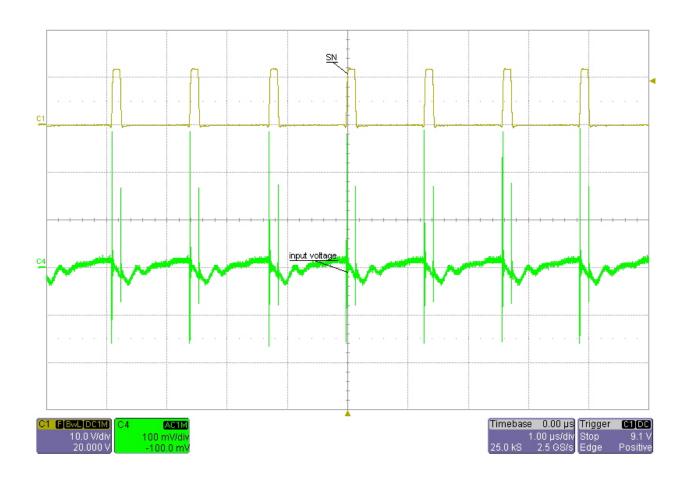


3.3 Load regulation



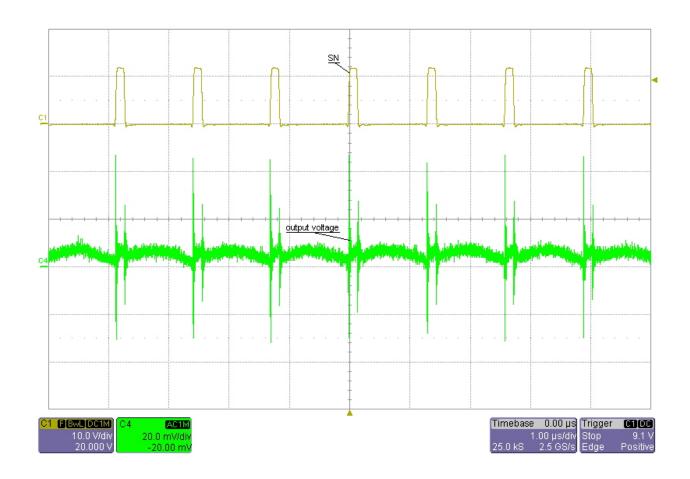


3.4 Input ripple voltage



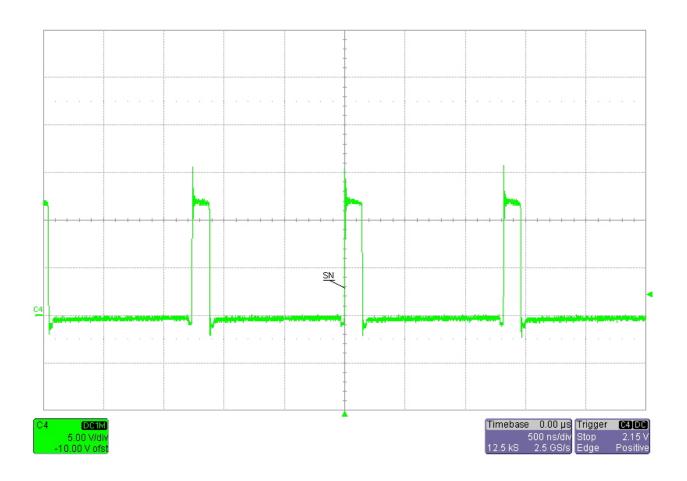


3.5 Output ripple voltage





3.6 Switch Node

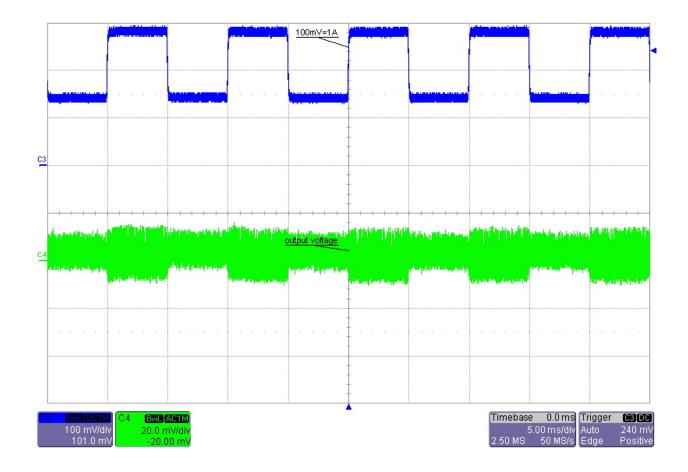




3.7 Load Transients

Input voltage = 12V

Load current = 1.5A to 3.05A



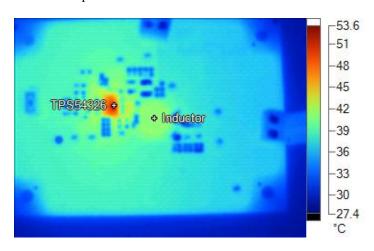


3.8 Thermal Analysis

The images below show the infrared images taken from the FlexCam after 15min at full load (1.05V@3.05A).

Input voltage
$$= 12V$$

Ambient temperature $= 25^{\circ}C$

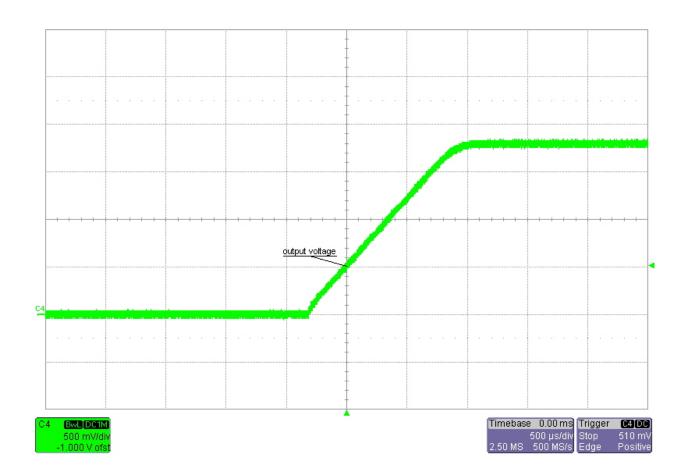


Name	Temperature	
Inductor	41.2°C	
TPS54326	51.5°C	



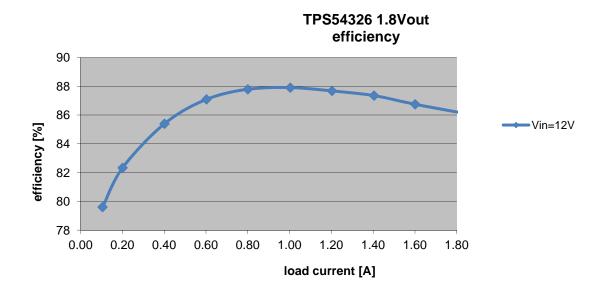
4 TPS54326EVM (<u>1.8V@1.74A</u>)

4.1 Startup

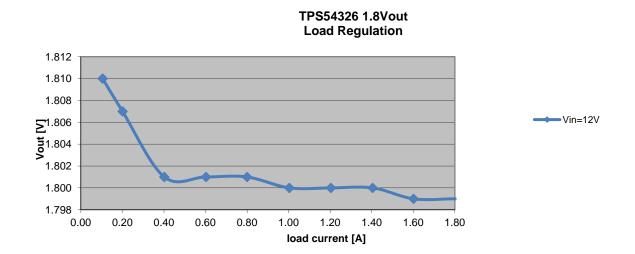




4.2 Efficiency

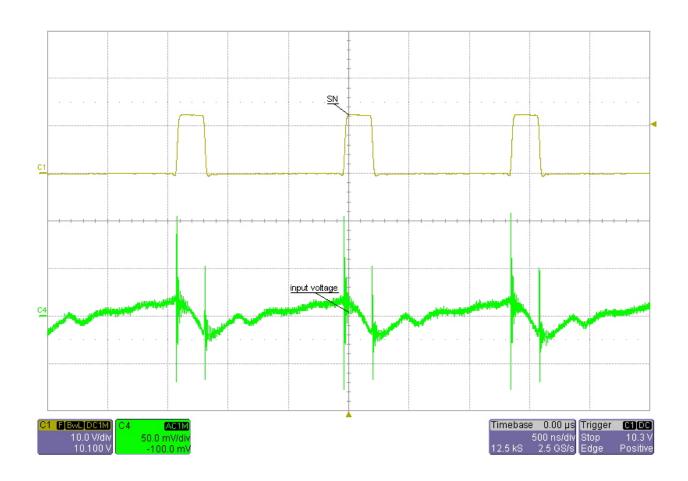


4.3 Load regulation



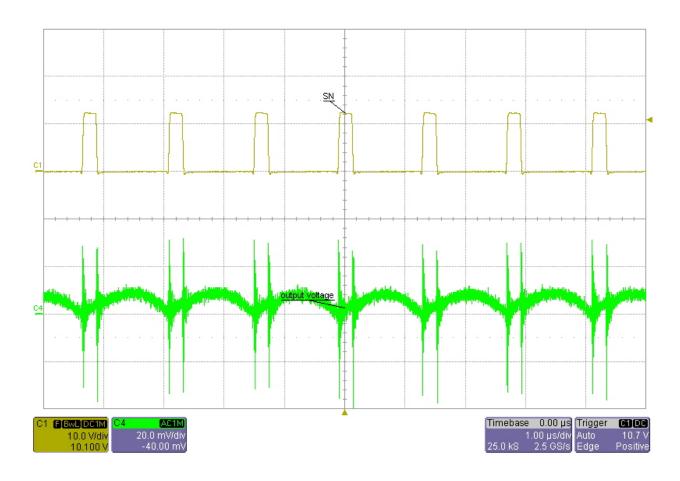


4.4 Input ripple voltage



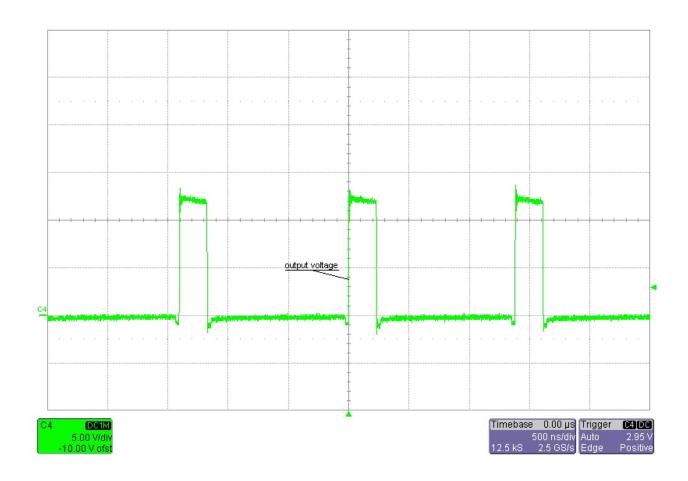


4.5 Output ripple voltage





4.6 Switch Node

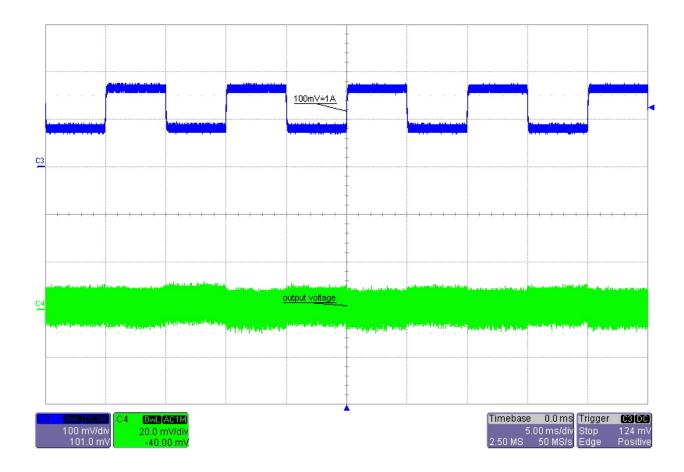




4.7 Load Transients

Input voltage = 12V

Load current = 0.8A to 1.8A

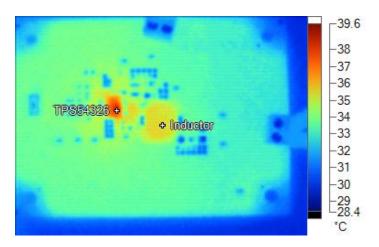




4.8 Thermal Analysis

The images below show the infrared images taken from the FlexCam after 15min at full load (1.8V@1.74A).

Input voltage = 12VAmbient temperature $= 25^{\circ}C$

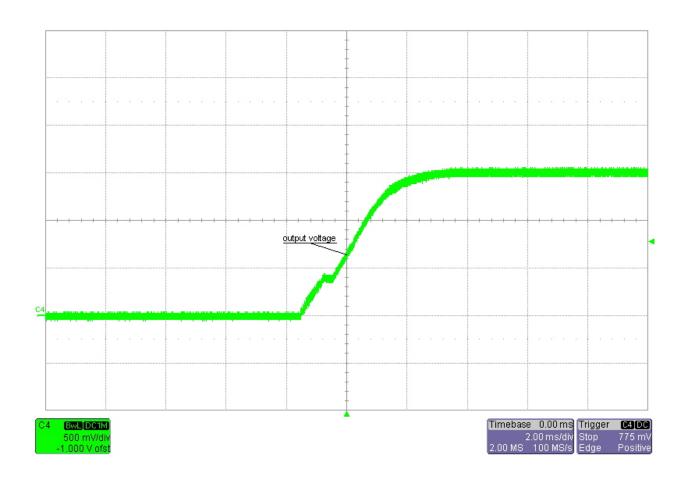


Name	Temperature	
Inductor	35.4°C	
TPS54326	38.7°C	



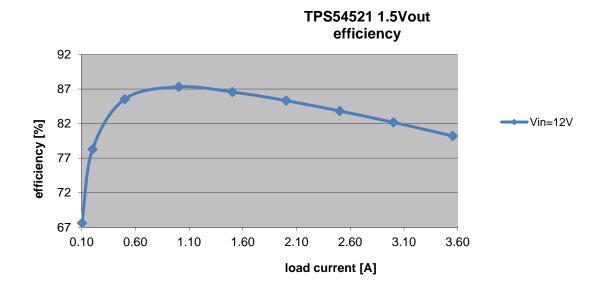
5 TPS54521EVM (<u>1.5V@3.55A</u>)

5.1 Startup

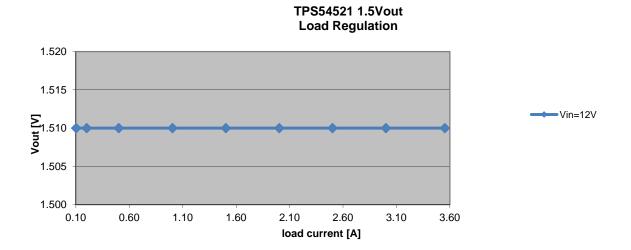




5.2 Efficiency

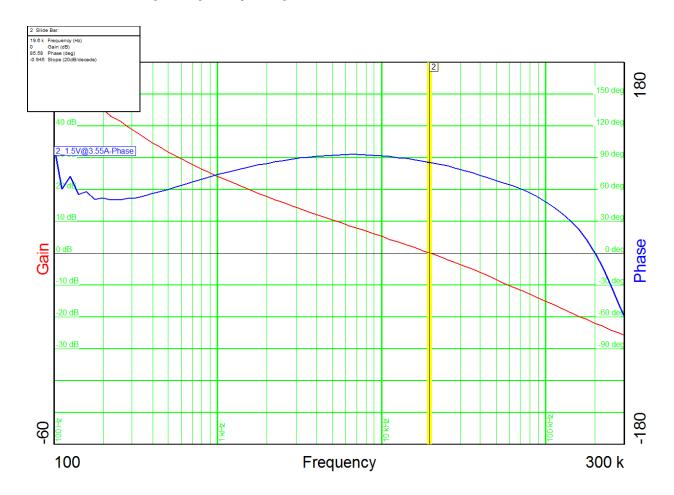


5.3 Load regulation





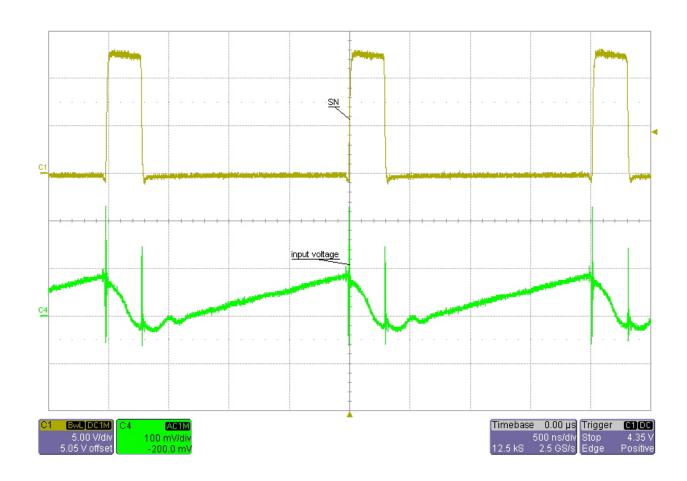
5.4 Control Loop Frequency Response



Input voltage = 12VPhase margin = 85.6° Bandwidth = 19.6 kHz

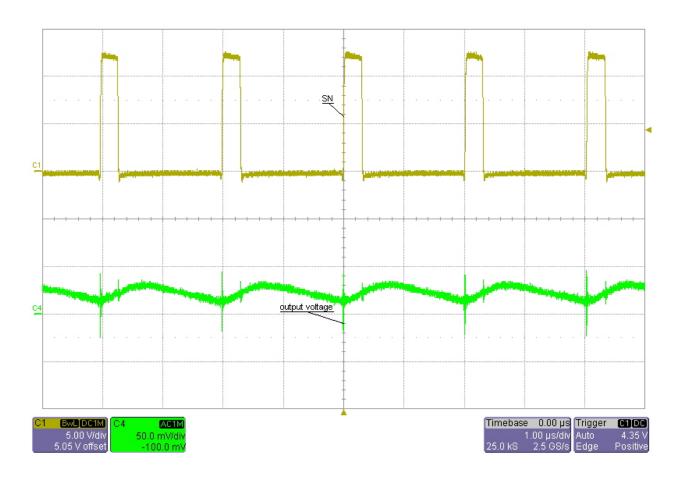


5.5 Input ripple voltage



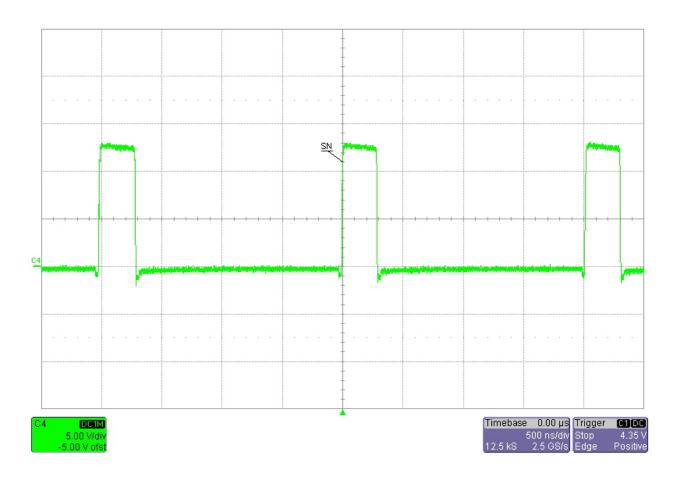


5.6 Output ripple voltage





5.7 Switch Node

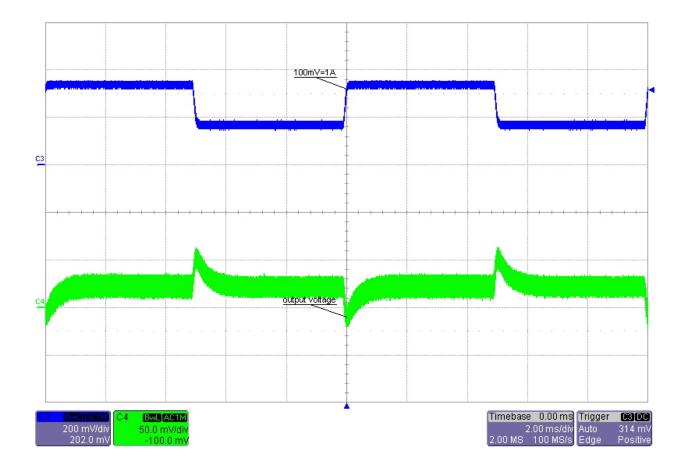




5.8 Load Transients

Input voltage = 12V

Load current = 1.8A to 3.6A



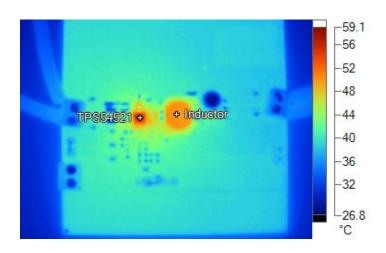


5.9 Thermal Analysis

The images below show the infrared images taken from the FlexCam after 15min at full load (1.5V@3.55A).

Input voltage
$$= 12V$$

Ambient temperature $= 25^{\circ}C$



Name	Temperature	
Inductor	50.1°C	
TPS54521	58.0°C	

PMP7170 RevB Test Results



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- 1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
- 2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
- 3. Since the EVM is not a completed product, it may not meet all applicable regulatory and safety compliance standards (such as UL, CSA, VDE, CE, RoHS and WEEE) which may normally be associated with similar items. You assume full responsibility to determine and/or assure compliance with any such standards and related certifications as may be applicable. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.

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